TOP Detector for Particle Identification at the Belle II Experiment

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Belle II Experiment and PID

- Belle II experiment
 - e^+e^- collision at Υ resonances.
 - Target integrated luminosity of 50 ab⁻¹ (×50 of Belle).
 - Precision studies on B, c, τ, ...
 for searching for new physics.
 - Particle identification (PID) at Belle II
 - K/ π efficiency > 95% (~90% at Belle),
 - K/ π fake rate < 5 % (10-15% at Belle).

Barrel PID: TOP detector Endcap PID: ARICH detector



TOP (Time-of-Propagation) Detector

- Cherenkov photons are propagated in the quartz, and detected by the MCP-PMTs (~20 photons detected).
- Velocity β is measured by the position and the time of the photons.



Hit-time difference between π^{\pm} and K^{\pm} due to

- difference of time of flight btw π^{\pm} and K[±] from IP to TOP: ~50 ps/m,
- difference of time of propagation of the Cherenkov photon: ~75 ps/m.



Key issues: I) ensure photon efficiency and 2) maintain the photon angles.

• Requirements for polishing

Flatness	< 6.3 µm
Perpendicularity	< 20 arcsec
Parallelism	< 4 arcsec
Roughness	< 5 Å (RMS)

Additional requirements

Bulk transmittance (τ)	> 98 %/m
Surface reflectance (R)	> 99.9 %/bounce

For a Corning 7980 0D prototype bar,

 $\tau = (99.4 \pm 0.2)$ %/m, R = (99.92 ± 0.01) %/bounce at Ref. angle 56°.

Glue for Quartz Bars

Alignment using micrometer heads.



Position and angle adjustable by $O(10) \mu m$ and $O(10) \mu rad$, respectively. (One-order better than the requirements.) Quartz supported by plastics.



Quartz flatness ~10 μ m.



Quartz Bar Box

- Support quartz bar with PEEK buttons, enabling total reflection at the quartz surface.
- Box made of aluminum honeycomb panels (low mass).





MCP-PMTs (Micro Channel Plate PMTs)

- Developed by Nagoya Univ. and Hamamatsu Co.
 4 x 4 channels per PMT. 32 PMTs per TOP module.
 square shape
 cross-sectional view
 MCP
- QE > 24% at 380 nm (NaKSbCs photocathode).
- Collection Eff. = 50-55% (~MCP aperture ratio).
- Gain of 2×10^6 at ~3.4 kV; 1 photon detection.
- Transit time spread (TTS) ~ 40 ps.
- Work in 1.5 T magnetic field.



Electronics

Based on a waveform-sampling ASIC.

G.Varner, "Experience with the first generation deep sampling ASICs IRS and BLAB3", Workshop on Timing Detectors: Electronics, Medical and Part. Phys. Appl., Cracow, 2010. G.Varner, "Deeper Sampling CMOS Transient Waveform Recording ASICs", TIPP 2011.





 4×10^{9} samples / sec. Chip intrinsic time resolution of <25 psec. Works for >5 µs trigger latency; multi-hit buffering for 30 kHz L1 trigger accept.

Calibration of the time and the charge requires a significant learning curve.

Backup Electronics for Performance Tests

K. Inami, "TOP counter prototype R&D", RICH 2010.

Based on constant fraction discriminator (CFD).

MCP-PMT 16 channels are merged into 4 at the MCP-PMT socket.



Time resolution \sim 50 psec.

Calibration relatively simpler. Can be used for TOP performance tests.

Beam Test Overview

Performance of the TOP detector tested using 2.0 GeV/c e⁺ beam at LEPS (Laser Electron Photon beamline at SPring-8).



- Data taken for both IRS3B and CFD readout.
- Beam timing from the accelerator RF with a resolution of < 25 psec.
- Test highly supported by the LEPS collaborators.

Beam Test Preliminary Output

Data taken by CFD readout

MC



- Good agreement of the Cherenkov ring image between data and MC.
 - The distribution for data obtained without event selection so far.
 - Channel-by-channel time origin alignment using laser data.
- Will estimate the β resolution for e⁺ (directly related to the PID performance).

Analysis ongoing also for the data taken with IRS3B readout.

Summary

- TOP detector developed for barrel PID at Belle II.
 - Quartz: maintain Cherenkov-photon efficiency and paths.
 - MCP-PMTs: detect photons with QE > 24% and TTS ~ 40 psec.
 - Electronics: waveform sampling, CFD for performance test.
- Performance test using full-size prototype at LEPS/SPring-8.
 - Good agreement of Cherenkov-ring image btw data and MC.
 - Analysis ongoing for evaluating PID performance.

Backup Slides

Bulk transmittance measurement



 $I_0(1 - R_0)\tau(1 - R_1) = I_1$

T: bulk transmittance

I₀, I₁: laser intensity (Meas. by PD) R₀, R₁: intensity for reflection (Calc. by Fresnel's Eq.)

Requirement: > 98%/m

Surface reflectance measurement



 $I_0(1-R_0)\alpha^N e^{-\frac{L}{\Lambda}\sqrt{1+\left(\frac{bN}{L}\right)^2}}(1-R_1) = I_1$

α: surface reflectanceN: number of bouncesL/b: quartz length/thickness

 I_0, I_1 : laser intensity (Meas. by PD) R_0, R_1 : intensity for reflection (Calc. by Fresnel's Eq.) Λ : absorption factor (Calc. from bulk transmittance)

Requirement: > 99.90%





Full TOP, measured numbers

Rbias+OP846	40 W
ASICs	57.6W
SCRODs	11.2W
HV	13.6W
Total	122.4W

May be possible to tune biases lower

About 31W per board-stack module



Beam Test at LEPS



Time Origin Calibration Using Laser Data

Preliminary

Channel-by-channel time origin alignment using the first peak of the TDC distribution.

Laser image after time origin alignment

